

## Features

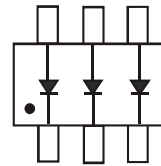
- Fast Switching Speed: max. 50ns
- Continuous Reverse Voltage: max. 200V
- Repetitive Peak Reverse Voltage: max. 250V
- Repetitive Peak Forward Current: max. 1A
- Small Surface Mount Package
- For General Purpose Switching Applications
- **Lead Free/RoHS Compliant (Note 1)**
- **"Green" Device (Notes 2 and 3)**

## Mechanical Data

- Case: SOT26
- Case Material: Molded Plastic, "Green" Molding Compound, Note 5. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Copper Alloy leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Orientation: See Diagram
- Weight: 0.009 grams (approximate)



Top View



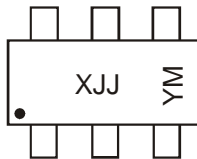
Top View  
Internal Schematic

## Ordering Information (Notes 3)

Part Number	Case	Packaging
BAS21TM-7	SOT26	3000/Tape & Reel

- Notes:
1. No purposefully added lead.
  2. Diodes Inc.'s "Green" policy can be found on our website at <http://www.diodes.com>.
  3. For packaging details, go to our website at <http://www.diodes.com>.

## Marking Information



XJJ = Product Type Marking Code  
 YM = Date Code Marking  
 Y = Year (ex: Z = 2012)  
 M = Month (ex: 9 = September)

### Date Code Key

Year	2011	2012	2013	2014	2015	2016	2017	2018
Code	Y	Z	A	B	C	D	E	F

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

### Maximum Ratings @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage	$V_{RM}$	250	V
Peak Repetitive Reverse Voltage	$V_{RRM}$	250	V
Working Peak Reverse Voltage	$V_{RWM}$		
DC Blocking Voltage	$V_R$		
RMS Reverse Voltage	$V_{R(RMS)}$	177	V
Forward Continuous Current (Note 4)	$I_{FM}$	200	mA
Average Rectified Output Current (Note 4)	$I_O$	250	mA
Non-Repetitive Peak Forward Surge Current	$I_{FSM}$	@ $t = 10\mu\text{s}$	10
		@ $t = 100\mu\text{s}$	6
		@ $t = 10\text{ms}$	2

### Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 4)	$P_D$	300	mW
Thermal Resistance Junction to Ambient Air (Note 4)	$R_{\theta JA}$	417	$^\circ\text{C}/\text{W}$
Operating and Storage Temperature Range	$T_J, T_{STG}$	-65 to +150	$^\circ\text{C}$

### Electrical Characteristics @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 5)	$V_{(BR)R}$	250	—	V	$I_R = 100\mu\text{A}$
Forward Voltage	$V_F$	—	1.0 1.25	V	$I_F = 100\text{mA}$ $I_F = 200\text{mA}$
Reverse Current (Note 5)	$I_R$	—	100 100	nA $\mu\text{A}$	$V_R = 200\text{V}$ $V_R = 200\text{V}, T_J = 150^\circ\text{C}$
Total Capacitance	$C_T$	—	5	pF	$V_R = 0, f = 1.0\text{MHz}$
Reverse Recovery Time	$t_{rr}$	—	50	ns	$I_F = I_R = 30\text{mA}$ , $I_{rr} = 0.1 \times I_R, R_L = 100\Omega$

Notes: 4. Part mounted on FR-4 board with recommended pad layout, which can be found on our website at <http://www.diodes.com/datasheets/ap02001.pdf>.  
Short duration pulse test used to minimize self-heating effect.

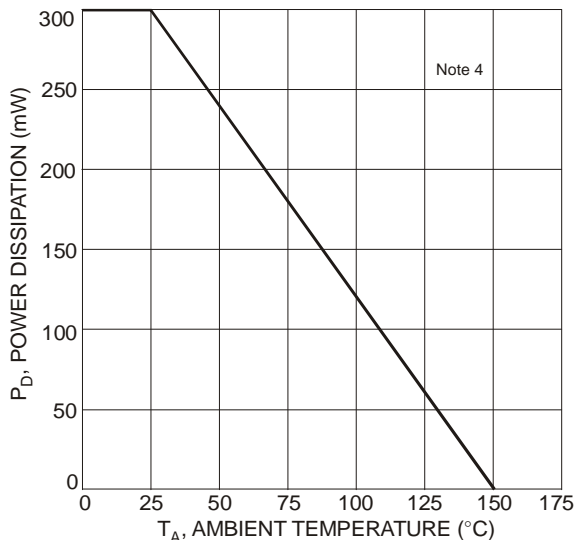


Fig. 1 Power Derating Curve, Total Package

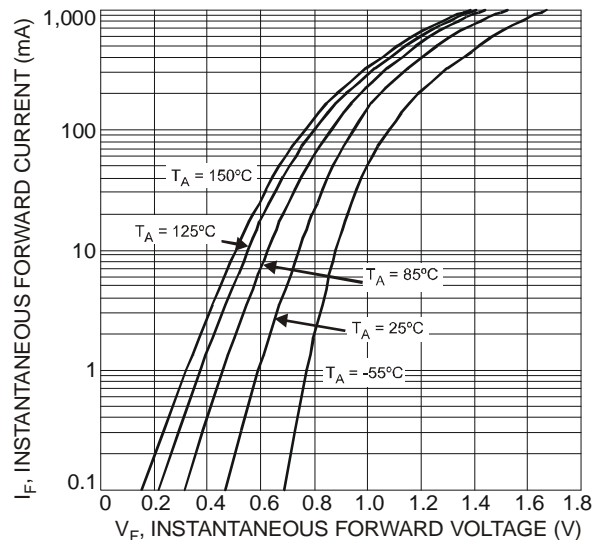


Fig. 2 Typical Forward Characteristics, Per Element

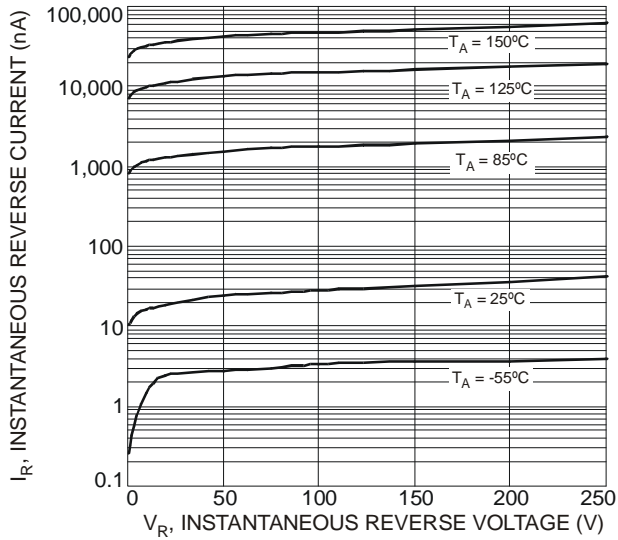


Fig. 3 Typical Reverse Characteristics, Per Element

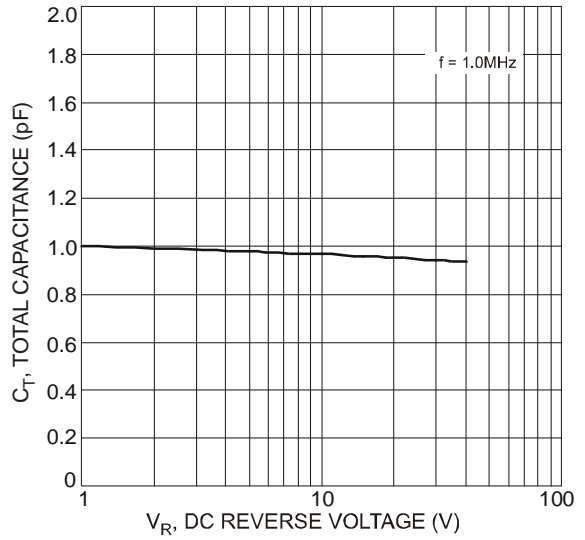
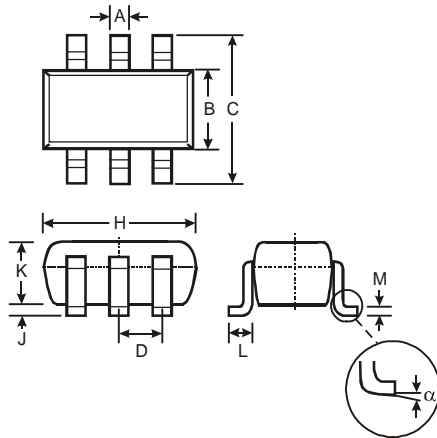


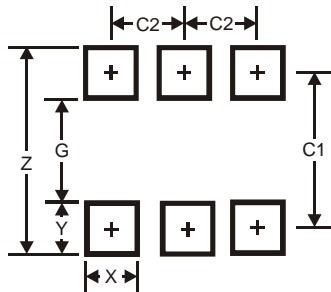
Fig. 4 Total Capacitance vs. Reverse Voltage, Per Element

**Package Outline Dimensions**



SOT26			
Dim	Min	Max	Typ
A	0.35	0.50	0.38
B	1.50	1.70	1.60
C	2.70	3.00	2.80
D	—	—	0.95
H	2.90	3.10	3.00
J	0.013	0.10	0.05
K	1.00	1.30	1.10
L	0.35	0.55	0.40
M	0.10	0.20	0.15
$\alpha$	0°	8°	—
All Dimensions in mm			

**Suggested Pad Layout**



Dimensions	Value (in mm)
Z	3.20
G	1.60
X	0.55
Y	0.80
C1	2.40
C2	0.95

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